505986453 03/26/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHENG-CHAU CHEN	04/20/2018
SHIH-PEI CHOU	04/20/2018
MING-CHE LEE	04/20/2018
KUO-MING WU	04/20/2018
CHENG-HSIEN CHOU	04/20/2018
CHENG-YUAN TSAI	04/20/2018
YEUR-LUEN TU	04/20/2018

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.
Street Address:	NO. 8, LI-HSIN RD. 6
Internal Address:	HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16723041

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	20151323/24061.3491US03
NAME OF SUBMITTER:	JANIE MARTINEZ-HOLM
SIGNATURE:	/Janie Martinez-Holm/

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DATE SIGNED: 03/26/2020

Total Attachments: 3
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PATENT REEL: 052235 FRAME: 0968

Docket No.: 20151323 / 24061.3491US02

Customer No.: 000042717

ASSIGNMENT

WHEREAS, we,

(1)	Sheng-Chau Chen	of	Tainan City, Taiwan (R.O.C.)
(2)	Shih-Pei Chou	of	Tainan City, Taiwan (R.O.C.)
(3)	Ming-Che Lee	of	Tainan City, Taiwan (R.O.C.)
(4)	Kuo-Ming Wu	of	Hsinchu County, Taiwan (R.O.C.)
(5)	Cheng-Hsien Chou	of	Tainan City, Taiwan (R.O.C.)
(6)	Cheng-Yuan Tsai	of	Hsin-Chou County, Taiwan (R.O.C.)
(7)	Yeur-Luen Tu	of	Taichung, Taiwan (R.O.C.)

have invented certain improvements in

SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD THEREOF

for which we have executed an application for Letters Patent of the United States of America, of even date filed herewith; and X __ filed on 10-06-2017 and assigned application number 15/727,041; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD., ("TSMC"), No. 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu 300-78, Taiwan, Republic of China, is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any

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country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	SHENG-CHAU CHEN	
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Dated: 20\8 /2	1/20	Sheng - Chan Chen Inventor Signature
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Residence Address:	No.6, Aly. 26, Ln. 167, Tong?? Taiwan (R.O.C.)	an Rd., Annan Dist., Tainan City 70952,
Dated: <u>>018</u> 4	- [>0	Shih-Pei Chow Inventor Signature
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Indianto del constanto

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